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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/739,229	12/18/2003	Byoung Hee Cho	29936/39870	1123	
4743	7590 03/03/2005		EXAM	EXAMINER	
MARSHALL, GERSTEIN & BORUN LLP 6300 SEARS TOWER			NHU, DAVID		
233 S. WAC	· · -		ART UNIT	PAPER NUMBER	
CHICAGO, IL 60606			2818		
			DATE MAILED: 03/03/2009	5	

Please find below and/or attached an Office communication concerning this application or proceeding.

				HI'r			
-		Application No.	Applicant(s)				
Office Action Commons		10/739,229	CHO, BYOUNG HEE				
	Office Action Summary	Examiner	Art Unit				
		David Nhu	2818				
Period f	The MAILING DATE of this communication app or Reply	pears on the cover sheet with the c	orrespondence address				
THE - Extended after a lf the lf North a lf North Any	MORTENED STATUTORY PERIOD FOR REPL' MAILING DATE OF THIS COMMUNICATION. ensions of time may be available under the provisions of 37 CFR 1.1 r SIX (6) MONTHS from the mailing date of this communication. e period for reply specified above is less than thirty (30) days, a reply o period for reply is specified above, the maximum statutory period v ure to reply within the set or extended period for reply will, by statute reply received by the Office later than three months after the mailing ned patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a reply be ting within the statutory minimum of thirty (30) day will apply and will expire SIX (6) MONTHS from a cause the application to become ABANDONE	nely filed /s will be considered timely. In the mailing date of this communication. ID (35 U.S.C. § 133).				
Status			•				
1) 又	Responsive to communication(s) filed on 18 D	ecember 2003.					
2a)□		action is non-final.					
3)	· · · · · · · · · · · · · · · · · · ·						
,—	closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.						
Disposi	tion of Claims						
4)🛛	Claim(s) <u>1-4</u> is/are pending in the application.						
	4a) Of the above claim(s) is/are withdrawn from consideration.						
5)[
6)⊠	Claim(s) 1-4 is/are rejected.						
7)							
8)[Claim(s) are subject to restriction and/o	r election requirement.	·				
Applicat	tion Papers						
9) 🗌	The specification is objected to by the Examine	r.					
10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.							
	Applicant may not request that any objection to the	drawing(s) be held in abeyance. Se	e 37 CFR 1.85(a).				
	Replacement drawing sheet(s) including the correct	ion is required if the drawing(s) is ob	jected to. See 37 CFR 1.121(d)	١.			
11)	The oath or declaration is objected to by the Ex	caminer. Note the attached Office	Action or form PTO-152.				
Priority	under 35 U.S.C. § 119						
-	Acknowledgment is made of a claim for foreign All b) Some * c) None of: 1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority document	s have been received. s have been received in Applicati rity documents have been receive	ion No				
*	See the attached detailed Office action for a list	of the certified copies not receive	ed.				
			RR				
Attachmei	nt(s)	7 (000)					
	ce of References Cited (PTO-892)	4) Interview Summary	(PTO-413)				
2) 🔲 Noti	ce of Draftsperson's Patent Drawing Review (PTO-948)	Paper No(s)/Mail D	ate				
	rmation Disclosure Statement(s) (PTO-1449 or PTO/SB/08) er No(s)/Mail Date	5)	Patent Application (PTO-152)				
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DETAILED ACTIONS

Specifications

1. Page 2, "HDP oxide film burying process" should be –High Density Plasma oxide film burying process--

Abstract

2. The abstract of the disclosure is objected to because legal phraseology such as "comprise" is used. Correction is required. See MPEP & 608.01(b).

Claim Rejections - 35 USC § 102

3. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 4. Claims 1-4 are rejected under 35 U.S.C. 102 (b) as being anticipated by Gousev et al (6,287,897 B1).

Regarding claim 1, Gousev, (see figures 1-10, col. 2, lines 60-67, col. 3, lines 1-67, col. 4, lines 1-25), teaches a method for forming a gate oxide film of a semiconductor device comprising the steps of: forming a gate oxide film 12 and a polysilicon film 16 sequentially on a semiconductor substrate 10; performing a nitrogen 14 ion implantation process for the semiconductor substrate including the gate oxide film and the polysilicon film; performing a thermal treatment process (RTP) to form barrier layers 18, 20 by combination of oxides and nitrogen at an interface between the semiconductor substrate and the gate oxide film, and at

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an interface between the gate oxide film and the polysilicon film (see figures 4., 5, 6); and forming a nitride film 32 on the polysilicon film 16 (see figure 10).

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Regarding claims 2-4, (see figures 1-12, col. 1-6), Gousev, also teaches forming a gate thermal treatment process is performed by a RTP spark annealing process; wherein the nitrogen ion implanting process is performed by using a source gas including nitrogen+, with a dose/concentration and an implantation energy of KeV (see col. 3, lines 7-24); wherein the RTP spark annealing process is performed at N2 gas ambient, a ramp up temperature (see col. 3, lines 25-37).

Claim Rejections - 35 USC § 102

5. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (e) the invention was described in a patent granted on an application for patent by another filed in the United States before the invention thereof by the applicant for patent, or on an international application by another who has fulfilled the requirements of paragraphs (1), (2), and (4) of section 371(c) of this title before the invention thereof by the applicant for patent.
- 6. Claims 1-4 are rejected under 35 U.S.C. 102(e) as being anticipated by Jeng (6,,562,730 B2).

Regarding claim 1, Jeng, (see figures 3-7, col. 4, lines 10-67, col. 5, 6, lines 1-67), teaches a method for forming a gate oxide film of a semiconductor device comprising the steps of: forming a gate oxide film 54 and a polysilicon film 56 sequentially on a semiconductor substrate 50; performing a nitrogen ion implantation process for the semiconductor substrate including the gate oxide film and the polysilicon film; performing a thermal treatment process (RTP) to form barrier layers 58 by combination of oxides and nitrogen at an interface between

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the semiconductor substrate and the gate oxide film, and at an interface between the gate oxide film and the polysilicon film (see figures 3, 4); and forming a nitride film 62 on the polysilicon film 56 (see figure 7).

Regarding claims 2-4, (see figures 1-7, col. 1-8), Jeng, also teaches forming a gate thermal treatment process is performed by a RTP spark annealing process; wherein the nitrogen ion implanting process is performed by using a source gas including nitrogen+, with a dose/concentration and an implantation energy of KeV (see col. 5, lines 25-51); wherein the RTP spark annealing process is performed at N2 gas ambient, a ramp up temperature (see col. 5, lines 25-29).

Conclusion

- 7. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure: Noble'116, Gardner'893, Kamal'348, Trivedi'395 are cited as of interest.
- 8. A shortened statutory period for response to this action is set to expired 3 (three) months and 0 (zero) day from the date of this letter. Failure to respond within the period for response will cause the application to become abandoned(see 710.02 (b)).
- 9. Any inquiry concerning this communication on earlier communications from the examiner should be directed to David Nhu (571)272-1792. The examiner can normally be reached on Monday-Friday from 7:30 AM to 5:00 PM. The examiner's supervisor, David Nelms can be reached on (571)272-1787.

The fax phone number for the organization where this application or proceeding is assigned is (703) 872-9306.

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Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0956.

Information regarding the status of an application may be obtained from the patent application information retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished

system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private

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PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

David Nhu \$-

February 29, 2005